

Features

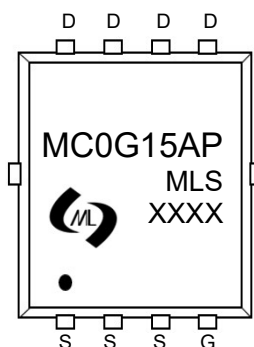
- High density cell design for ultra low $R_{DS(on)}$
- Fully characterized avalanche voltage and current
- Excellent package for good heat dissipation

Product Summary

V_{DS}	$R_{DS(ON)}$ MAX	I_D MAX
-60V	100mΩ@-10V	-15A
	125mΩ@-4.5V	

Application

- PWM applications
- Power management
- Load switch

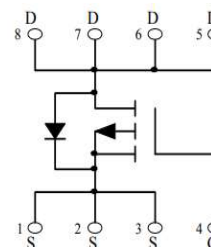


Marking and pin assignment

MC0G15AP: Device code
XXXX: Code



PDFN5X6-8L view



Schematic diagram



Pb-Free



Halogen-Free

Absolute Maximum Ratings ($T_A=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Rating	Unit
--------	-----------	--------	------

Common Ratings ($T_C=25^\circ\text{C}$ Unless Otherwise Noted)

V_{DS}	Drain-Source Breakdown Voltage	-60	V
V_{GS}	Gate-Source Voltage	± 20	V
T_J	Maximum Junction Temperature	150	$^\circ\text{C}$
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ\text{C}$
I_S	Diode Continuous Forward Current	$T_C=25^\circ\text{C}$ -15	A

Mounted on Large Heat Sink

I_{DM}	Pulse Drain Current Tested	$T_C=25^\circ\text{C}$ -59	A
I_D	Continuous Drain Current	$T_C=25^\circ\text{C}$ -15	A
P_D	Maximum Power Dissipation	$T_C=25^\circ\text{C}$ 40	W
E_{AS}	Single pulse Avalanche Energy ^{Note1}	10	mJ

Ordering Information (Example)

Type	Package	Marking	Minimum Package(pcs)	Inner Box Quantity(pcs)	Outer Carton Quantity(pcs)	Delivery Mode
MC0G15AP	PDFN5X6-8L	MC0G15AP	5,000	10,000	70,000	13"reel

Electrical Characteristics (TJ=25℃ unless otherwise noted)						
Symbol	Parameter	Condition	Min	Typ	Max	Unit
Static Electrical Characteristics @ TJ = 25℃ (unless otherwise stated)						
BV _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =-250μA	-60	--	--	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-60V, V _{GS} =0V	--	--	-1	μA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±20V, V _{DS} =0V	--	--	±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =-250μA	-1.0	-1.8	-2.5	V
R _{DS(on)}	Drain-Source On-State Resistance	V _{GS} =-10V, I _D =-10A	--	84	100	mΩ
		V _{GS} =-4.5V, I _D =-8A	--	100	125	mΩ
Dynamic Electrical Characteristics @ TJ = 25℃ (unless otherwise stated)						
C _{ISS}	Input Capacitance	V _{DS} =-30V, V _{GS} =0V, f=1MHz	--	1630	--	pF
C _{OSS}	Output Capacitance		--	90	--	pF
C _{RSS}	Reverse Transfer Capacitance		--	78	--	pF
Switching Characteristics						
Q _g	Total Gate Charge	V _{DS} =-30V, I _D =-12A, V _{GS} =-10V	--	37.5	--	nC
Q _{gs}	Gate Source Charge		--	4	--	nC
Q _{gd}	Gate Drain Charge		--	7.2	--	nC
t _{d(on)}	Turn-on Delay Time	V _{DD} =-30V, I _D =-12A, V _{GS} =-10V, R _G =3.3Ω	--	11	--	nS
t _r	Turn-on Rise Time		--	14	--	nS
t _{d(off)}	Turn-Off Delay Time		--	33	--	nS
t _f	Turn-Off Fall Time		--	13	--	nS
Source- Drain Diode Characteristics						
V _{SD}	Forward on voltage	Tj=25℃, Is=-12A,	--	--	-1.2	V

Note:

- 1、EAS Test condition: V_{DD}=30V, L=0.5mH, V_{GS}=20V, I_{AS}=6.65A Starting T_J = 25°C

Typical Operating Characteristics

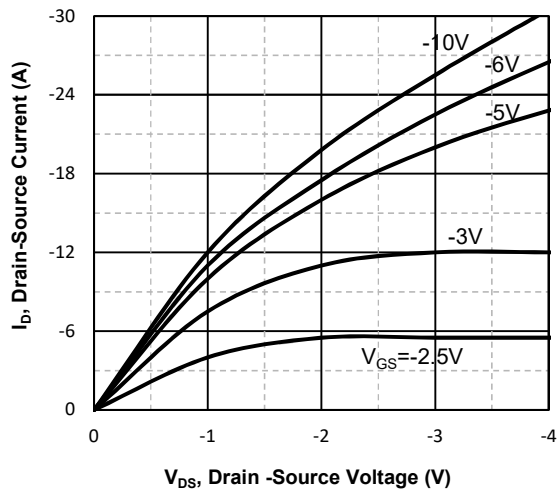


Fig1. Typical Output Characteristics

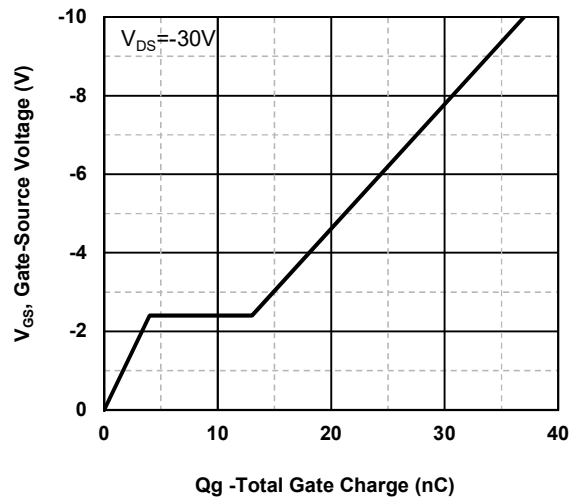


Fig2. Typical Gate Charge Vs. Gate-Source Voltage

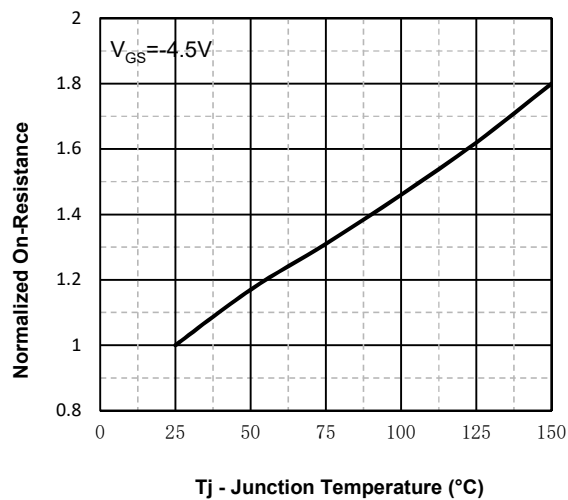


Fig3. Normalized On-Resistance Vs. Temperature

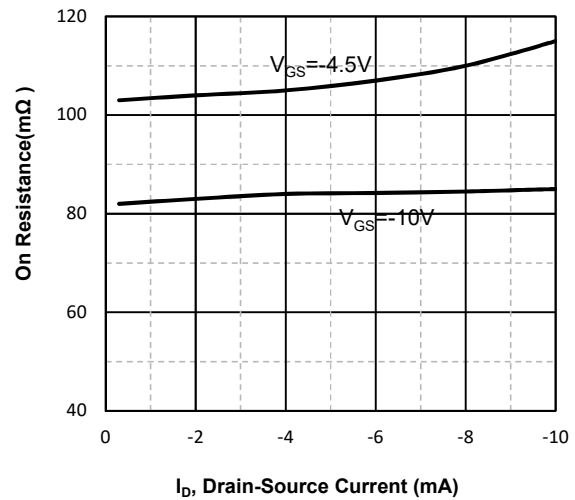


Fig4. On Resistance Vs. Drain-Source Current

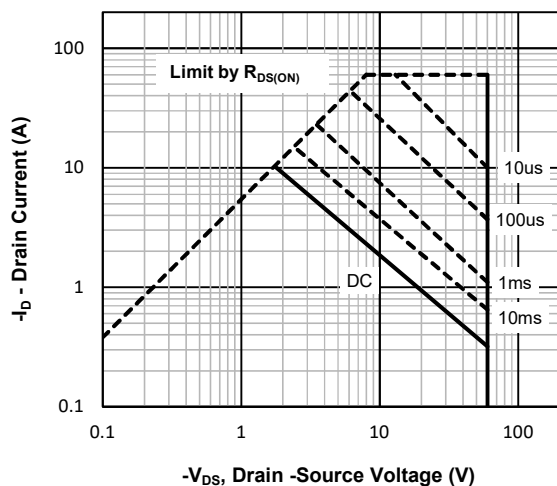


Fig5. Maximum Safe Operating Area

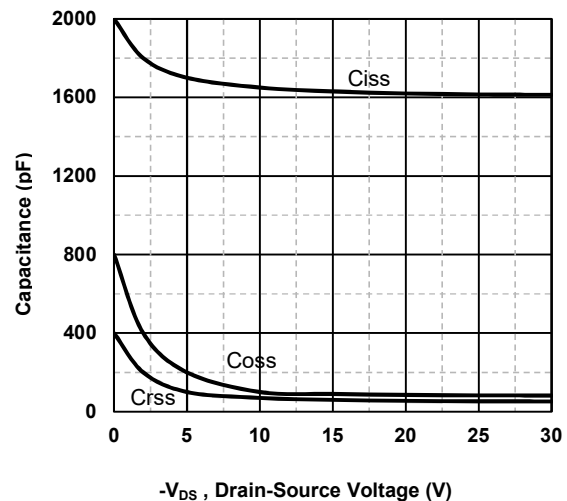
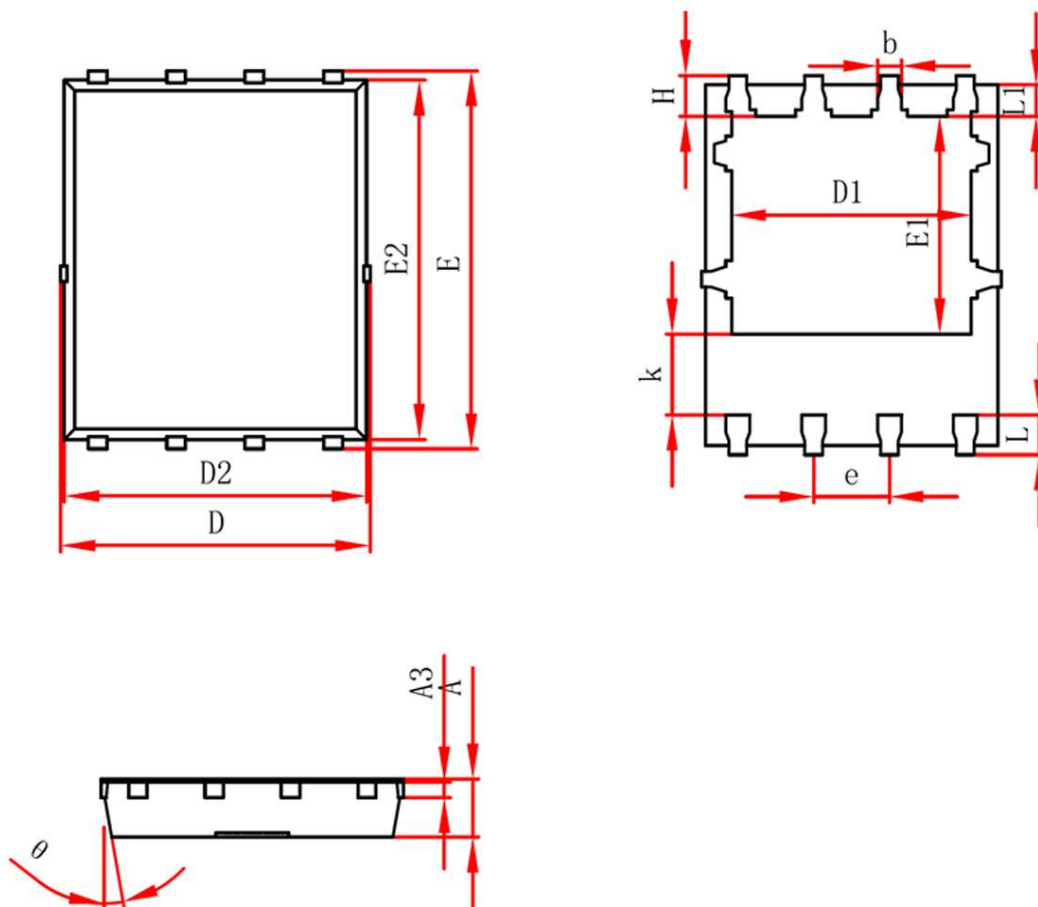


Fig6 Typical Capacitance Vs. Drain-Source Voltage

PDFN5X6-8L Package information



Symbol	Dimensions in Millimeters(mm)		Dimensions In Inches	
	Min	Max	Min	Max
A	0.950	1.050	0.035	0.039
A3	0.254REF.		0.010REF.	
D	4.950	5.050	0.196	0.200
E	5.950	6.050	0.235	0.239
D1	4.026	4.126	0.159	0.163
E1	3.510	3.610	0.139	0.143
D2	4.850	4.950	0.192	0.196
E2	5.700	5.800	0.225	0.229
k	1.190	1.390	0.047	0.055
b	0.300	0.400	0.012	0.016
e	1.270TYP.		0.050TYP.	
L	0.559	0.711	0.022	0.028
L1	0.424	0.576	0.017	0.023
H	0.574	0.726	0.023	0.029
θ	10°	12°	10°	12°